

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>TETSUYA ISHII</td> <td>07/26/2013</td> </tr> <tr> <td>AKIO SHOKAKU</td> <td>07/26/2013</td> </tr> <tr> <td>KOICHIRO IWASA</td> <td>07/30/2013</td> </tr> <tr> <td>MASANORI NAKAMURA</td> <td>07/24/2013</td> </tr> </tbody> </table>		Name	Execution Date	TETSUYA ISHII	07/26/2013	AKIO SHOKAKU	07/26/2013	KOICHIRO IWASA	07/30/2013	MASANORI NAKAMURA	07/24/2013
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RECEIVING PARTY DATA											
<table border="1"> <tr> <td>Name:</td> <td>SEKISUI CHEMICAL CO., LTD.</td> </tr> <tr> <td>Street Address:</td> <td>4-4, NISHITEMMA 2-CHOME, KITA-KU, OSAKA-SHI</td> </tr> <tr> <td>City:</td> <td>OSAKA</td> </tr> <tr> <td>State/Country:</td> <td>JAPAN</td> </tr> <tr> <td>Postal Code:</td> <td>530-8565</td> </tr> </table>		Name:	SEKISUI CHEMICAL CO., LTD.	Street Address:	4-4, NISHITEMMA 2-CHOME, KITA-KU, OSAKA-SHI	City:	OSAKA	State/Country:	JAPAN	Postal Code:	530-8565
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PROPERTY NUMBERS Total: 1											
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Application Number:	14123867										
CORRESPONDENCE DATA											
Fax Number:	(202)721-8250										
Phone:	202 721-8200										
Email:	wlp@wenderoth.com										
<i>Correspondence will be sent via US Mail when the email attempt is unsuccessful.</i>											
Correspondent Name:	WENDEROTH, LIND & PONACK, L.L.P.										
Address Line 1:	1030 15TH STREET, N.W.										
Address Line 2:	SUITE 400 EAST										
Address Line 4:	WASHINGTON, DISTRICT OF COLUMBIA 20005-1503										
ATTORNEY DOCKET NUMBER:	2013-1924A										
NAME OF SUBMITTER:	FATEMA SERAJ										

Signature:	/Fatema Seraj/
Date:	12/04/2013
Total Attachments: 2 source=executed assignment#page1.tif source=executed assignment#page2.tif	

ASSIGNMENT

In consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration paid to each of the undersigned

Insert Name(s)
of Inventor(s) (1) Tetsuya ISHII; (2) Akio SHOKAKU; (3) Koichiro IWASA; and (4) Masanori NAKAMURA
the undersigned hereby sell(s) and assign(s) to

Insert Name(s)
of Assignee(s) SEKISUI CHEMICAL CO., LTD.
Address of 4-4, Nishitemma 2-chome, Kita-ku, Osaka-shi, Osaka 530-8565 Japan
(hereinafter designated as the Assignee) the entire right, title and interest for the United States as defined in 35 USC 100, in the invention known as

Title of
Invention CONTACTLESS POWER TRANSFER SYSTEM, CONTACTLESS POWER TRANSFER DEVICE,
CONTACTLESS POWER TRANSFER PROGRAM AND CONTACTLESS POWER TRANSFER METHOD

Date of
Signing
of Application for which an application for patent in the United States has been executed by the undersigned
on _____

The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation, division or reissue thereof and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such interference.

The undersigned agree(s) to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee.

The undersigned hereby authorize(s) and request(s) the Commissioner of Patents to issue any and all Letters Patents of the United States resulting from said application or any division or divisions or continuing or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the firm of WENDEROTH, LIND & PONACK, L.L.P., 2033 K Street, N.W., Suite 800, Washington, D.C. 20006-1021, the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent Office for recordation of this document.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

Date 26/7/2013, Name of the Inventor Tetsuya ISHII

Date 26/7/2013, Name of the Inventor Akio SHOKAKU

Date 30/7/2013, Name of the Inventor Koichiro IWASA

Date 24/7/2013, Name of the Inventor Masanori NAKAMURA

(This assignment should preferably be acknowledged before a United States Consul. If not, then the execution by the Inventor(s) should be witnessed by at least two witnesses who sign here.)

Witness _____

Witness _____

ACKNOWLEDGMENT

_____ } ss

This _____ day of _____, 20____, before me personally came the above-named me personally known as the individual(s) who executed the foregoing assignment, who did acknowledge to me that he (they) executed the same of his (their) own free will for the purposes therein set forth.

SEAL

Official Signature

Official Title

The above application may be more particularly identified as follows:

U.S. Application Serial No. _____ Filing Date _____

Applicant Reference Number _____ Atty Docket No. _____

Title of Invention _____